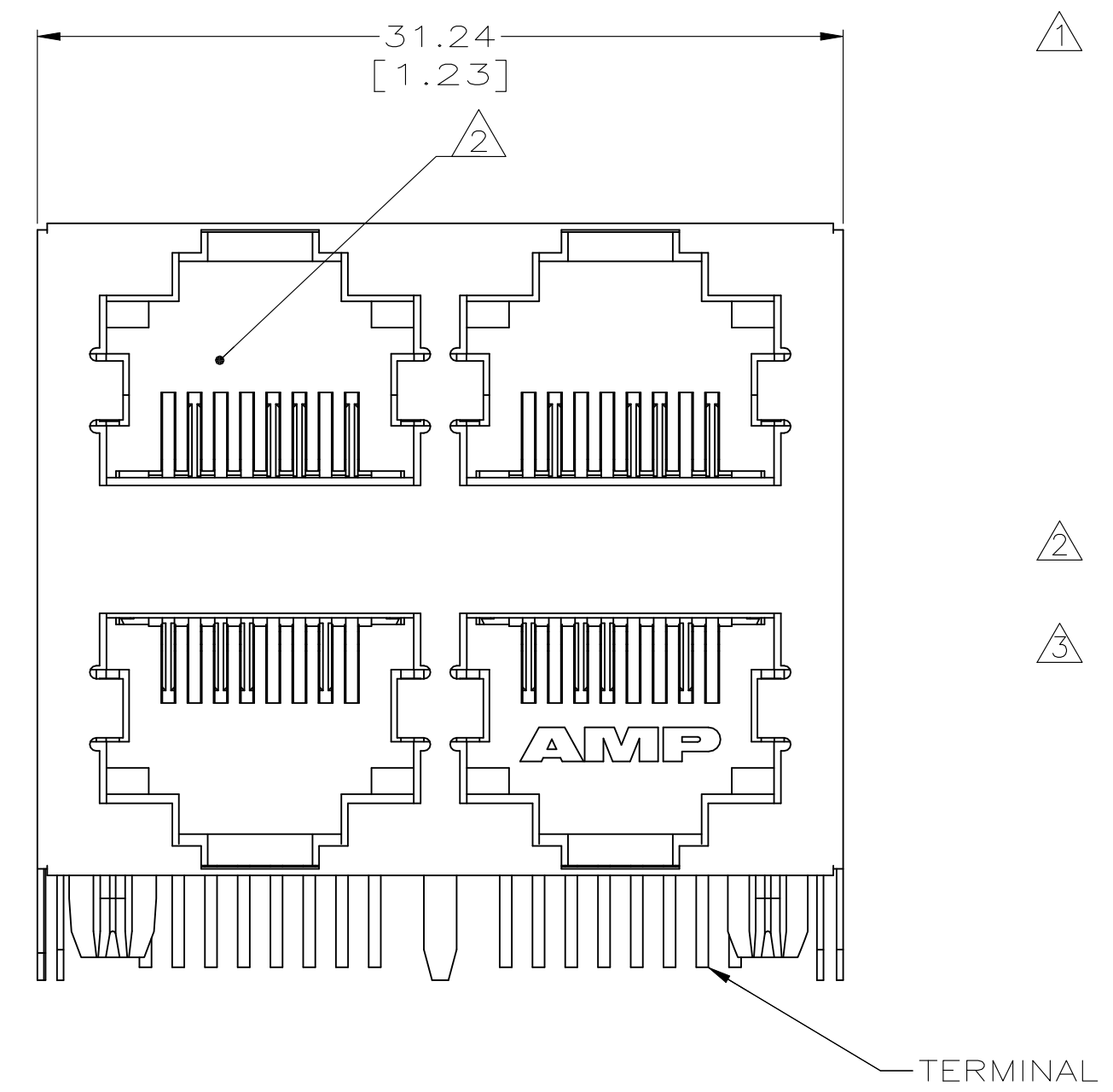
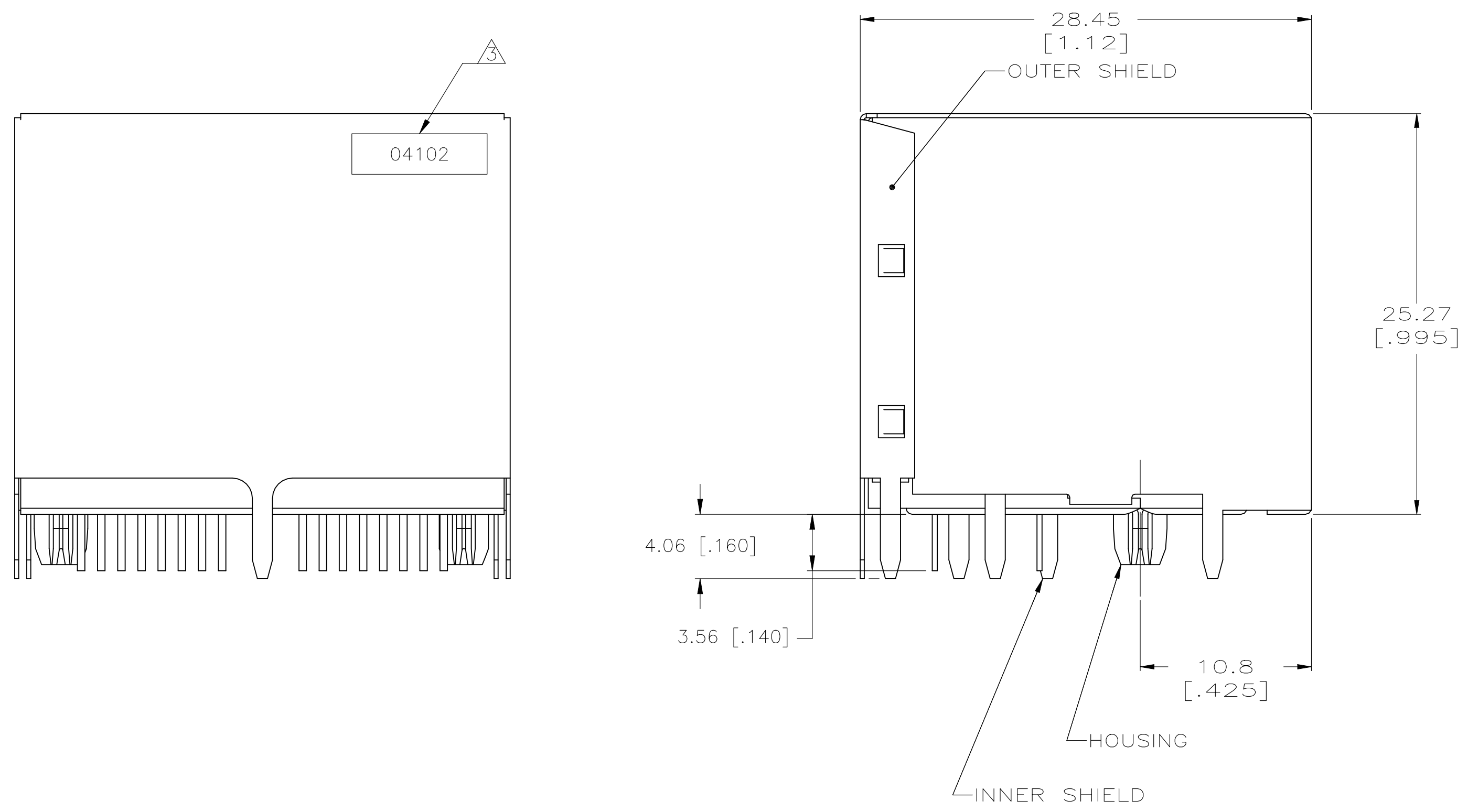
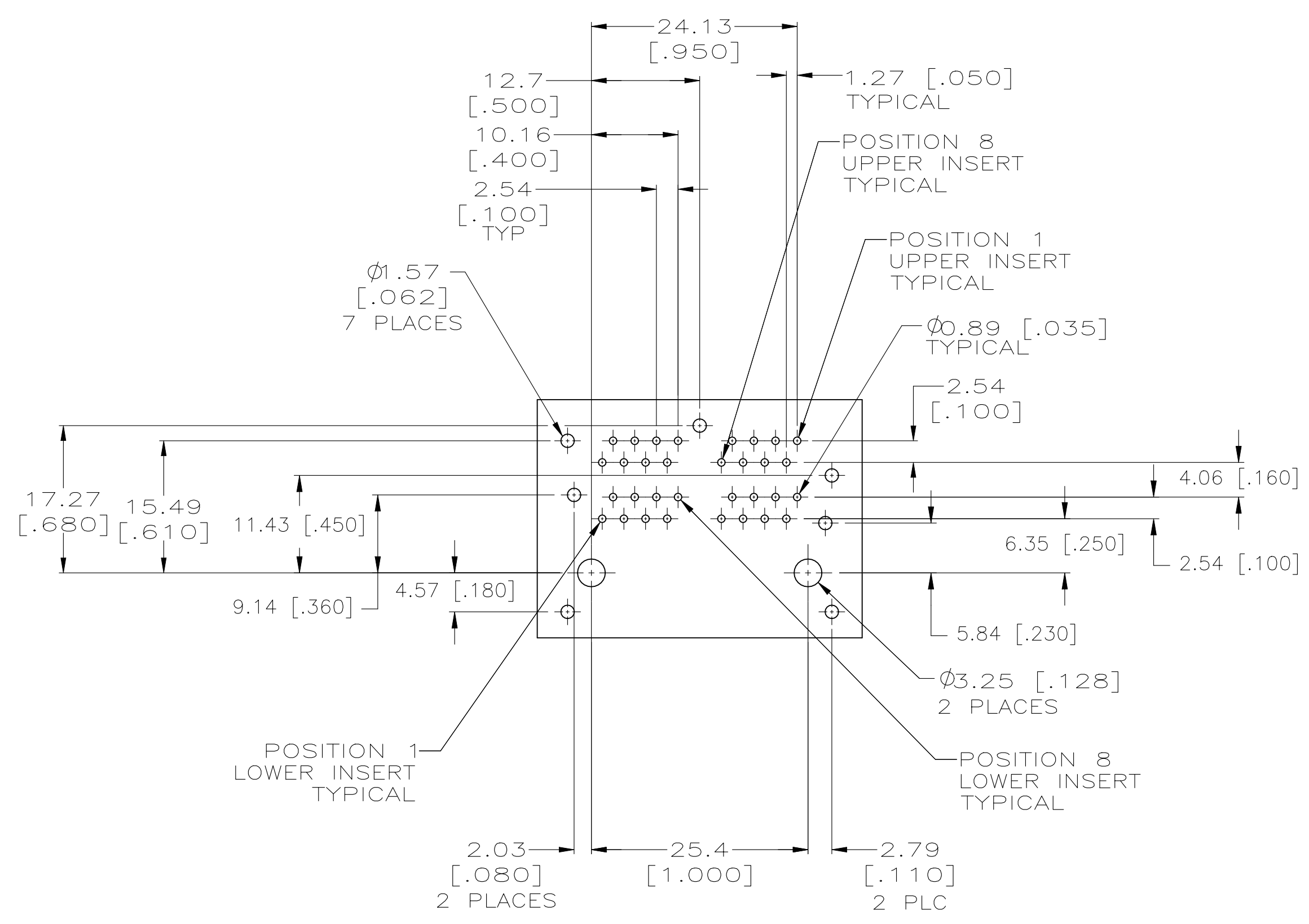
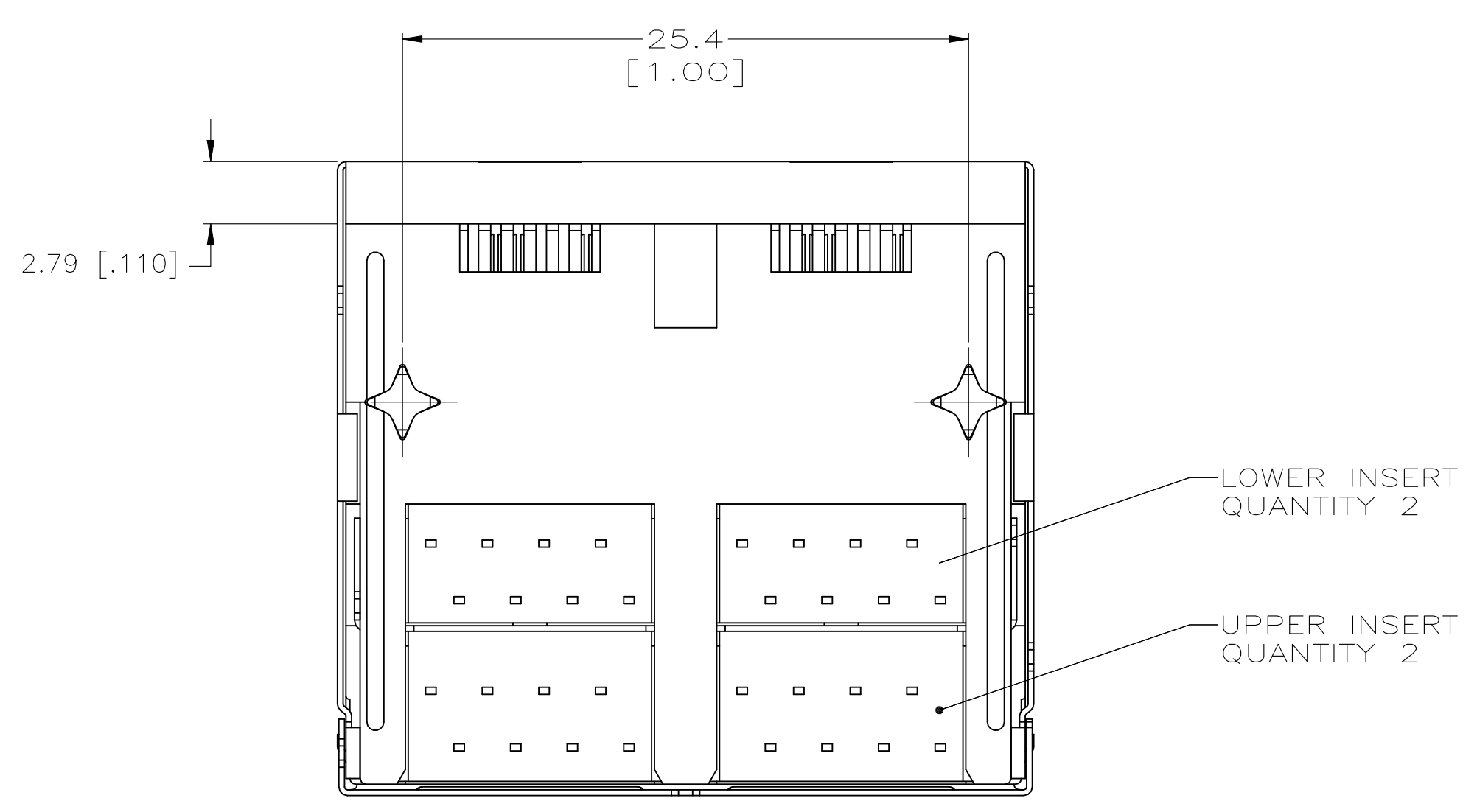




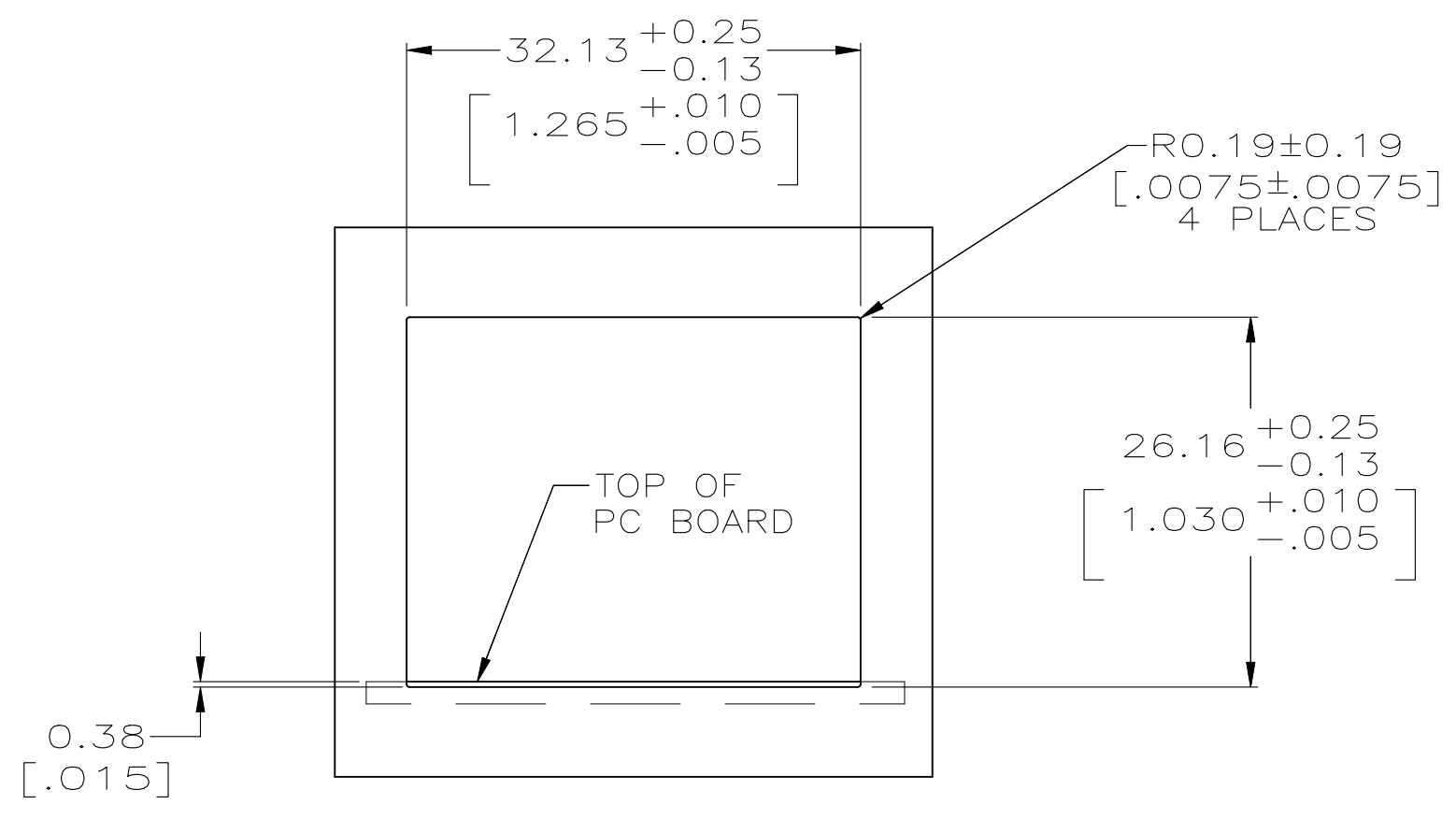
MATERIAL:
HOUSING – PCT POLYESTER, BLACK, UL94V-0.
OVERMOLDED TERMINAL ARRAY – PBT, BROWN.
TERMINALS – 0.33 [.013] THICK PHOS BRONZE
PLATED WITH 1.27um [.000050] MIN THICK
HARD GOLD IN LOCALIZED AREA AND 3.81um
[.000150] MIN THICK MATTE TIN IN SOLDER
AREA OVER 1.27um [.000050] MIN THICK
NICKEL UNDERPLATE.
OUTER SHIELD AND INNER SHIELD – 0.25 [.010]
THICK COPPER ALLOY PLATED WITH 1.27 um
[.000050] MINIMUM NICKEL AND 2.03 um
[.000080] MINIMUM HOT TIN DIP ON PCB
GROUND TABS.

JACK CAVITY CONFORMS TO FCC RULES AND
REGULATIONS, PART 68 SUBPART F.

DATE CODE LOCATED ON REAR OF PART
APPROXIMATELY AS SHOWN:
FIRST 2 DIGITS ARE LAST 2 DIGITS OF YEAR,
SECOND 2 DIGITS ARE MANUFACTURING
WORK WEEK,
LAST DIGIT IS DAY OF WEEK, WITH SUNDAY = 1.



PC BOARD LAYOUT VIEWED FROM COMPONENT SIDE
SCALE 2:1



SUGGESTED PANEL CUTOUT DIMENSIONS
SCALE 2:1

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED: <table><tr><td>0 PLC</td><td>± -</td></tr><tr><td>1 PLC</td><td>± -</td></tr><tr><td>2 PLC</td><td>± 0.25[.01]</td></tr><tr><td>3 PLC</td><td>± 0.13[.005]</td></tr><tr><td>4 PLC</td><td>± -</td></tr><tr><td>ANGLES</td><td>± -</td></tr></table>	0 PLC	± -	1 PLC	± -	2 PLC	± 0.25[.01]	3 PLC	± 0.13[.005]	4 PLC	± -	ANGLES	± -
0 PLC	± -												
1 PLC	± -												
2 PLC	± 0.25[.01]												
3 PLC	± 0.13[.005]												
4 PLC	± -												
ANGLES	± -												

DWN	A. FERNANDEZ-DOCK5	14JUN2005
CHK	J. WESTMAN	14JUN2005
APVD	S. FLICKINGER	14JUN2005

NAME	STACKED MODULAR JACK ASSEMBLY, 2 X 2 PORT, 8 POSITION, SHIELDED, PRINTED CIRCUIT BOARD GROUND, CATEGORY 5
PRODUCT SPEC	108-1163-2
APPLICATION SPEC	114-2048
WEIGHT	0.000000
CUSTOMER DRAWING	

SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
A1	00779	5569255	-

SCALE	4:1	SHEET	1 OF 1	REV	A3
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TE Connectivity